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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

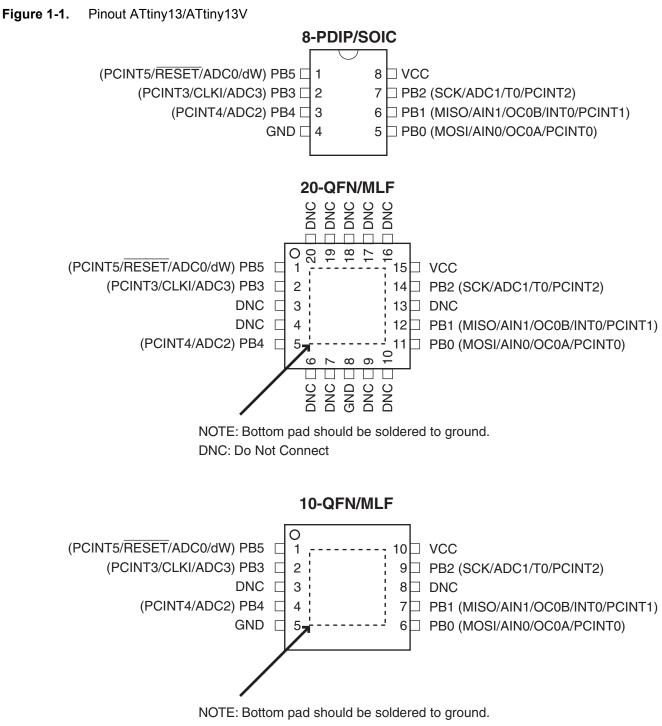
Product Status	Obsolete
Core Processor	AVR
Core Size	8-Bit
Speed	20MHz
Connectivity	-
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	6
Program Memory Size	1KB (512 x 16)
Program Memory Type	FLASH
EEPROM Size	64 x 8
RAM Size	64 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 4x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	8-SOIC (0.209", 5.30mm Width)
Supplier Device Package	8-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/attiny13-20si

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong



1. Pin Configurations



1.1 Pin Descriptions

1.1.1 VCC

Digital supply voltage.

1.1.2 GND

Ground.

1.1.3 Port B (PB5:PB0)

Port B is a 6-bit bi-directional I/O port with internal pull-up resistors (selected for each bit). The Port B output buffers have symmetrical drive characteristics with both high sink and source capability. As inputs, Port B pins that are externally pulled low will source current if the pull-up resistors are activated. The Port B pins are tri-stated when a reset condition becomes active, even if the clock is not running.

Port B also serves the functions of various special features of the ATtiny13 as listed on page 54.

1.1.4 RESET

Reset input. A low level on this pin for longer than the minimum pulse length will generate a reset, even if the clock is not running. The minimum pulse length is given in Table 18-1 on page 115. Shorter pulses are not guaranteed to generate a reset.

The reset pin can also be used as a (weak) I/O pin.

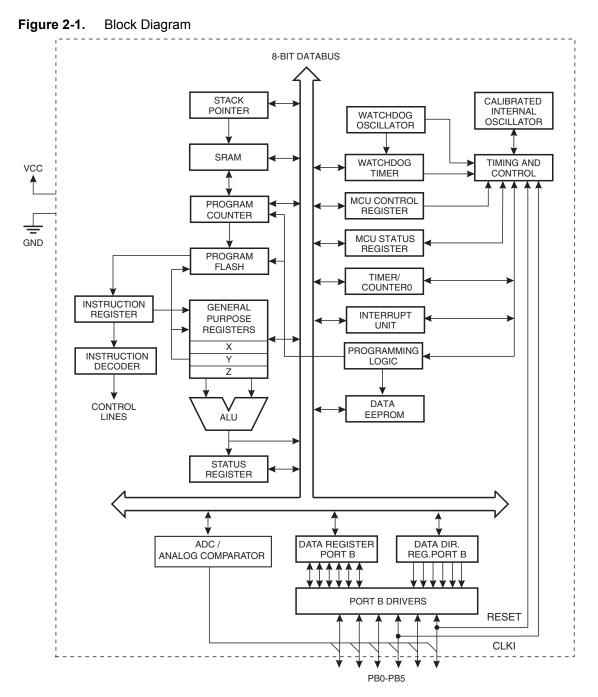




2. Overview

The ATtiny13 is a low-power CMOS 8-bit microcontroller based on the AVR enhanced RISC architecture. By executing powerful instructions in a single clock cycle, the ATtiny13 achieves throughputs approaching 1 MIPS per MHz allowing the system designer to optimize power consumption versus processing speed.

2.1 Block Diagram



The AVR core combines a rich instruction set with 32 general purpose working registers. All 32 registers are directly connected to the Arithmetic Logic Unit (ALU), allowing two independent registers to be accessed in one single instruction executed in one clock cycle. The resulting architecture is more code efficient while achieving throughputs up to ten times faster than conventional CISC microcontrollers.

The ATtiny13 provides the following features: 1K byte of In-System Programmable Flash, 64 bytes EEPROM, 64 bytes SRAM, 6 general purpose I/O lines, 32 general purpose working registers, one 8-bit Timer/Counter with compare modes, Internal and External Interrupts, a 4-channel, 10-bit ADC, a programmable Watchdog Timer with internal Oscillator, and three software selectable power saving modes. The Idle mode stops the CPU while allowing the SRAM, Timer/Counter, ADC, Analog Comparator, and Interrupt system to continue functioning. The Power-down mode saves the register contents, disabling all chip functions until the next Interrupt or Hardware Reset. The ADC Noise Reduction mode stops the CPU and all I/O modules except ADC, to minimize switching noise during ADC conversions.

The device is manufactured using Atmel's high density non-volatile memory technology. The On-chip ISP Flash allows the Program memory to be re-programmed In-System through an SPI serial interface, by a conventional non-volatile memory programmer or by an On-chip boot code running on the AVR core.

The ATtiny13 AVR is supported with a full suite of program and system development tools including: C Compilers, Macro Assemblers, Program Debugger/Simulators, and Evaluation kits.





3. General Information

3.1 Resources

A comprehensive set of drivers, application notes, data sheets and descriptions on development tools are available for download at http://www.atmel.com/avr.

3.2 Code Examples

This documentation contains simple code examples that briefly show how to use various parts of the device. These code examples assume that the part specific header file is included before compilation. Be aware that not all C compiler vendors include bit definitions in the header files and interrupt handling in C is compiler dependent. Please confirm with the C compiler documentation for more details.

3.3 Data Retention

Reliability Qualification results show that the projected data retention failure rate is much less than 1 PPM over 20 years at 85°C or 100 years at 25°C.



- Notes: 1. For compatibility with future devices, reserved bits should be written to zero if accessed. Reserved I/O memory addresses should never be written.
 - 2. I/O Registers within the address range 0x00 0x1F are directly bit-accessible using the SBI and CBI instructions. In these registers, the value of single bits can be checked by using the SBIS and SBIC instructions.ome of the Status Flags are cleared by writing a logical one to them. Note that, unlike most other AVRs, the CBI and SBI instructions will only operation the specified bit, and can therefore be used on registers containing such Status Flags. The CBI and SBI instructions work with registers 0x00 to 0x1F only.

ATtiny13

5. Instruction Set Summary

Mnemonics	Operands	Description	Operation	Flags	#Clocks
	ARITHMET	IC AND LOGIC INSTRUCTIONS			
ADD	Rd, Rr	Add two Registers	Rd ← Rd + Rr	Z,C,N,V,H	1
ADC	Rd, Rr	Add with Carry two Registers	$Rd \leftarrow Rd + Rr + C$	Z,C,N,V,H	1
ADIW	Rdl,K	Add Immediate to Word	Rdh:Rdl ← Rdh:Rdl + K	Z,C,N,V,S	2
SUB	Rd, Rr	Subtract two Registers	Rd ← Rd - Rr	Z,C,N,V,H	1
SUBI	Rd, K	Subtract Constant from Register	$Rd \leftarrow Rd - K$	Z,C,N,V,H	1
SBC	Rd, Rr	Subtract with Carry two Registers	$Rd \leftarrow Rd - Rr - C$	Z,C,N,V,H	1
SBCI	Rd, K	Subtract with Carry Constant from Reg.	Rd ← Rd - K - C	Z,C,N,V,H	1
SBIW	Rdl,K	Subtract Immediate from Word	Rdh:Rdl ← Rdh:Rdl - K	Z,C,N,V,S	2
AND	Rd, Rr	Logical AND Registers	Rd ← Rd • Rr	Z,N,V	1
ANDI OR	Rd, K	Logical AND Register and Constant	$Rd \leftarrow Rd \bullet K$	Z,N,V	1
OR	Rd, Rr Rd, K	Logical OR Registers Logical OR Register and Constant	$Rd \leftarrow Rd \lor Rr$ $Rd \leftarrow Rd \lor K$	Z,N,V Z,N,V	1
EOR	Rd, R Rd, Rr	Exclusive OR Registers	$Rd \leftarrow Rd \oplus Rr$	Z,N,V Z,N,V	1
COM	Rd	One's Complement	$Rd \leftarrow 0xFF - Rd$	Z,C,N,V	1
NEG	Rd	Two's Complement	$Rd \leftarrow 0x00 - Rd$	Z,C,N,V,H	1
SBR	Rd,K	Set Bit(s) in Register	$Rd \leftarrow Rd \lor K$	Z,N,V	1
CBR	Rd,K	Clear Bit(s) in Register	$Rd \leftarrow Rd \bullet (0xFF - K)$	Z,N,V	1
INC	Rd	Increment	$Rd \leftarrow Rd + 1$	Z,N,V	1
DEC	Rd	Decrement	$Rd \leftarrow Rd - 1$	Z,N,V	1
TST	Rd	Test for Zero or Minus	$Rd \leftarrow Rd \bullet Rd$	Z,N,V	1
CLR	Rd	Clear Register	$Rd \leftarrow Rd \oplus Rd$	Z,N,V	1
SER	Rd	Set Register	Rd ← 0xFF	None	1
		ANCH INSTRUCTIONS			
RJMP	k	Relative Jump	$PC \leftarrow PC + k + 1$	None	2
IJMP		Indirect Jump to (Z)	PC ← Z	None	2
RCALL	k	Relative Subroutine Call	PC ← PC + k + 1	None	3
ICALL		Indirect Call to (Z)	$PC \leftarrow Z$	None	3
RET		Subroutine Return	$PC \leftarrow STACK$	None	4
RETI		Interrupt Return	$PC \leftarrow STACK$	I	4
CPSE	Rd,Rr	Compare, Skip if Equal	if (Rd = Rr) PC \leftarrow PC + 2 or 3	None	1/2/3
CP	Rd,Rr	Compare	Rd – Rr	Z, N,V,C,H	1
CPC	Rd,Rr	Compare with Carry	Rd – Rr – C	Z, N,V,C,H	1
CPI	Rd,K	Compare Register with Immediate	Rd – K	Z, N,V,C,H	1
SBRC	Rr, b	Skip if Bit in Register Cleared	if (Rr(b)=0) PC ← PC + 2 or 3	None	1/2/3
SBRS	Rr, b	Skip if Bit in Register is Set	if (Rr(b)=1) PC ← PC + 2 or 3	None	1/2/3
SBIC	P, b	Skip if Bit in I/O Register Cleared	if (P(b)=0) PC ← PC + 2 or 3	None	1/2/3
SBIS	P, b	Skip if Bit in I/O Register is Set	if (P(b)=1) PC ← PC + 2 or 3	None	1/2/3
BRBS	s, k	Branch if Status Flag Set	if $(SREG(s) = 1)$ then $PC \leftarrow PC+k + 1$	None	1/2
BRBC	s, k	Branch if Status Flag Cleared	if (SREG(s) = 0) then $PC \leftarrow PC+k + 1$	None	1/2
BREQ	k	Branch if Equal	if (Z = 1) then PC \leftarrow PC + k + 1	None	1/2
BRNE	k	Branch if Not Equal	if (Z = 0) then PC \leftarrow PC + k + 1	None	1/2
BRCS	k	Branch if Carry Set	if (C = 1) then PC \leftarrow PC + k + 1	None	1/2
BRCC	k	Branch if Carry Cleared	if (C = 0) then PC \leftarrow PC + k + 1	None	1/2
BRSH	k	Branch if Same or Higher	if (C = 0) then PC \leftarrow PC + k + 1	None	1/2
BRLO	k	Branch if Lower	if (C = 1) then PC \leftarrow PC + k + 1	None	1/2
BRMI	k	Branch if Minus	if (N = 1) then PC \leftarrow PC + k + 1	None	1/2
BRPL	k	Branch if Plus	if (N = 0) then PC \leftarrow PC + k + 1	None	1/2
BRGE	k	Branch if Greater or Equal, Signed	if $(N \oplus V=0)$ then PC \leftarrow PC + k + 1 if $(N \oplus V=1)$ then PC \leftarrow PC + k + 1	None	1/2
BRLT BRHS	k k	Branch if Less Than Zero, Signed	if $(N \oplus V= 1)$ then PC \leftarrow PC + k + 1 if $(H = 1)$ then PC \leftarrow PC + k + 1	None None	1/2 1/2
BRHS	k k	Branch if Half Carry Flag Set Branch if Half Carry Flag Cleared	if (H = 1) then PC \leftarrow PC + k + 1 if (H = 0) then PC \leftarrow PC + k + 1		1/2
BRTS	k k	Branch if T Flag Set	if (H = 0) then PC \leftarrow PC + k + 1 if (T = 1) then PC \leftarrow PC + k + 1	None	1/2
BRTC	k k	Branch if T Flag Cleared	if (T = 0) then PC \leftarrow PC + k + 1	None None	1/2
BRVS	k	Branch if Overflow Flag is Set	if (V = 1) then PC \leftarrow PC + k + 1	None	1/2
BRVS	k	Branch if Overflow Flag is Cleared	if (V = 0) then PC \leftarrow PC + k + 1	None	1/2
BRIE	k	Branch if Interrupt Enabled	if $(1 = 1)$ then PC \leftarrow PC + k + 1	None	1/2
BRID	k	Branch if Interrupt Disabled	if (I = 0) then PC \leftarrow PC + k + 1	None	1/2
		D BIT-TEST INSTRUCTIONS		Hone	1/4
SBI	P,b	Set Bit in I/O Register	I/O(P,b) ← 1	None	2
CBI	P,b	Clear Bit in I/O Register	$I/O(P,b) \leftarrow 0$	None	2
LSL	Rd	Logical Shift Left	$Rd(n+1) \leftarrow Rd(n), Rd(0) \leftarrow 0$	Z,C,N,V	1
LSR	Rd	Logical Shift Right	$Rd(n) \leftarrow Rd(n+1), Rd(0) \leftarrow 0$	Z,C,N,V	1
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Mnemonics	Operands	Description	Operation	Flags	#Clocks
ROR	Rd	Rotate Right Through Carry	$Rd(7) \leftarrow C, Rd(n) \leftarrow Rd(n+1), C \leftarrow Rd(0)$	Z,C,N,V	1
ASR	Rd	Arithmetic Shift Right $Rd(n) \leftarrow Rd(n+1), n=0.6$		Z,C,N,V	1
SWAP	Rd	Swap Nibbles	Rd(30)←Rd(74),Rd(74)←Rd(30)	None	1
BSET	s	Flag Set	SREG(s) ← 1	SREG(s)	1
BCLR	s	Flag Clear	$SREG(s) \leftarrow 0$	SREG(s)	1
BST	Rr, b	Bit Store from Register to T	$T \leftarrow Rr(b)$	Т	1
BLD	Rd, b	Bit load from T to Register	$Rd(b) \leftarrow T$	None	1
SEC		Set Carry	C ← 1	С	1
CLC		Clear Carry	C ← 0	С	1
SEN		Set Negative Flag	N ← 1	N	1
CLN		Clear Negative Flag	N ← 0	N	1
SEZ		Set Zero Flag	Z ← 1	Z	1
CLZ		Clear Zero Flag	Z ← 0	Z	1
SEI		Global Interrupt Enable		-	1
CLI		Global Interrupt Disable	1←0	1	1
SES		Set Signed Test Flag	S ← 1	S	1
CLS			<u> </u>	s	1
		Clear Signed Test Flag		V	
SEV		Set Twos Complement Overflow.	V ← 1		1
CLV		Clear Twos Complement Overflow	V ← 0	V	1
SET		Set T in SREG	T ← 1	Т	1
CLT		Clear T in SREG	$0 \rightarrow T$	Т	1
SEH		Set Half Carry Flag in SREG	H ← 1	Н	1
CLH		Clear Half Carry Flag in SREG	H ← 0	Н	1
	DATA	TRANSFER INSTRUCTIONS		-	•
MOV	Rd, Rr	Move Between Registers	$Rd \leftarrow Rr$	None	1
MOVW	Rd, Rr	Copy Register Word	$Rd+1:Rd \leftarrow Rr+1:Rr$	None	1
LDI	Rd, K	Load Immediate	$Rd \leftarrow K$	None	1
LD	Rd, X	Load Indirect	$Rd \leftarrow (X)$	None	2
LD	Rd, X+	Load Indirect and Post-Inc.	$Rd \leftarrow (X), X \leftarrow X + 1$	None	2
LD	Rd, - X	Load Indirect and Pre-Dec.	$X \leftarrow X - 1, Rd \leftarrow (X)$	None	2
LD	Rd, Y	Load Indirect	$Rd \leftarrow (Y)$	None	2
LD	Rd, Y+	Load Indirect and Post-Inc.	$Rd \leftarrow (Y), Y \leftarrow Y + 1$	None	2
LD	Rd, - Y	Load Indirect and Pre-Dec.	$Y \leftarrow Y - 1$, Rd $\leftarrow (Y)$	None	2
LDD	Rd,Y+q	Load Indirect with Displacement	$Rd \leftarrow (Y + q)$	None	2
LD	Rd, Z	Load Indirect	$Rd \leftarrow (Z)$	None	2
LD	Rd, Z+	Load Indirect and Post-Inc.	$Rd \leftarrow (Z), Z \leftarrow Z+1$	None	2
LD	Rd, -Z	Load Indirect and Pre-Dec.	$Z \leftarrow Z - 1, Rd \leftarrow (Z)$	None	2
LDD	Rd, Z+q	Load Indirect with Displacement	$Rd \leftarrow (Z + q)$	None	2
LDS	Rd, k	Load Direct from SRAM	$\frac{Rd \leftarrow (k)}{Rd \leftarrow (k)}$	None	2
ST	X, Rr	Store Indirect	(X) ← Rr	None	2
ST	X+, Rr	Store Indirect and Post-Inc.	$(X) \leftarrow \operatorname{Rr}, X \leftarrow X + 1$	None	2
ST	- X, Rr	Store Indirect and Posteric.	$X \leftarrow X - 1, (X) \leftarrow Rr$	None	2
ST	Y, Rr	Store Indirect	$(Y) \leftarrow Rr$	None	2
					2
ST ST	Y+, Rr	Store Indirect and Post-Inc.	$(Y) \leftarrow Rr, Y \leftarrow Y + 1$	None	2
-	- Y, Rr	Store Indirect and Pre-Dec.	$Y \leftarrow Y - 1, (Y) \leftarrow Rr$	None	
STD	Y+q,Rr	Store Indirect with Displacement	$(Y + q) \leftarrow Rr$	None	2
ST	Z, Rr	Store Indirect	(Z) ← Rr	None	2
ST	Z+, Rr	Store Indirect and Post-Inc.	$(Z) \leftarrow \operatorname{Rr}, Z \leftarrow Z + 1$	None	2
ST	-Z, Rr	Store Indirect and Pre-Dec.	$Z \leftarrow Z - 1, (Z) \leftarrow Rr$	None	2
STD	Z+q,Rr	Store Indirect with Displacement	(Z + q) ← Rr	None	2
STS	k, Rr	Store Direct to SRAM	$(k) \leftarrow Rr$	None	2
LPM		Load Program Memory	R0 ← (Z)	None	3
LPM	Rd, Z	Load Program Memory	$Rd \leftarrow (Z)$	None	3
LPM	Rd, Z+	Load Program Memory and Post-Inc	$Rd \leftarrow (Z), Z \leftarrow Z+1$	None	3
SPM		Store Program Memory	(z) ← R1:R0	None	
IN	Rd, P	In Port	$Rd \leftarrow P$	None	1
OUT	P, Rr	Out Port	P ← Rr	None	1
PUSH	Rr	Push Register on Stack	$STACK \leftarrow Rr$	None	2
POP	Rd	Pop Register from Stack	$Rd \leftarrow STACK$	None	2
		CONTROL INSTRUCTIONS			
NOP		No Operation		None	1
			(and appairing depart for Clean function)		1
SLEEP		Sleen			
SLEEP WDR		Sleep Watchdog Reset	(see specific descr. for Sleep function) (see specific descr. for WDR/Timer)	None None	1

6. Ordering Information

Speed (MHz) ⁽³⁾	Power Supply (V)	Ordering Code ⁽⁴⁾	Package ⁽²⁾	Operation Range	
10	1.8 - 5.5	ATtiny13V-10PU ATtiny13V-10SU ATtiny13V-10SUR ATtiny13V-10SSU ATtiny13V-10SSUR ATtiny13V-10MU ATtiny13V-10MUR ATtiny13V-10MMU ATtiny13V-10MMU	8P3 8S2 8S2 S8S1 S8S1 20M1 20M1 10M1 10M1	Industrial (-40°C to +85°C) ⁽¹⁾	
20	2.7 - 5.5	ATtiny13-20PU ATtiny13-20SU ATtiny13-20SUR ATtiny13-20SSU ATtiny13-20SSUR ATtiny13-20MU ATtiny13-20MUR ATtiny13-20MMU ATtiny13-20MMUR	8P3 8S2 8S2 S8S1 S8S1 20M1 20M1 10M1 10M1	Industrial (-40°C to +85°C) ⁽¹⁾	

Notes: 1. These devices can also be supplied in wafer form. Please contact your local Atmel sales office for detailed ordering information and minimum quantities.

- 2. All packages are Pb-free, halide-free and fully green and they comply with the European directive for Restriction of Hazardous Substances (RoHS).
- 3. For Speed vs. V_{CC} , see "Speed Grades" on page 117.
- 4. Code indicators:

- U: matte tin

- R: tape & reel

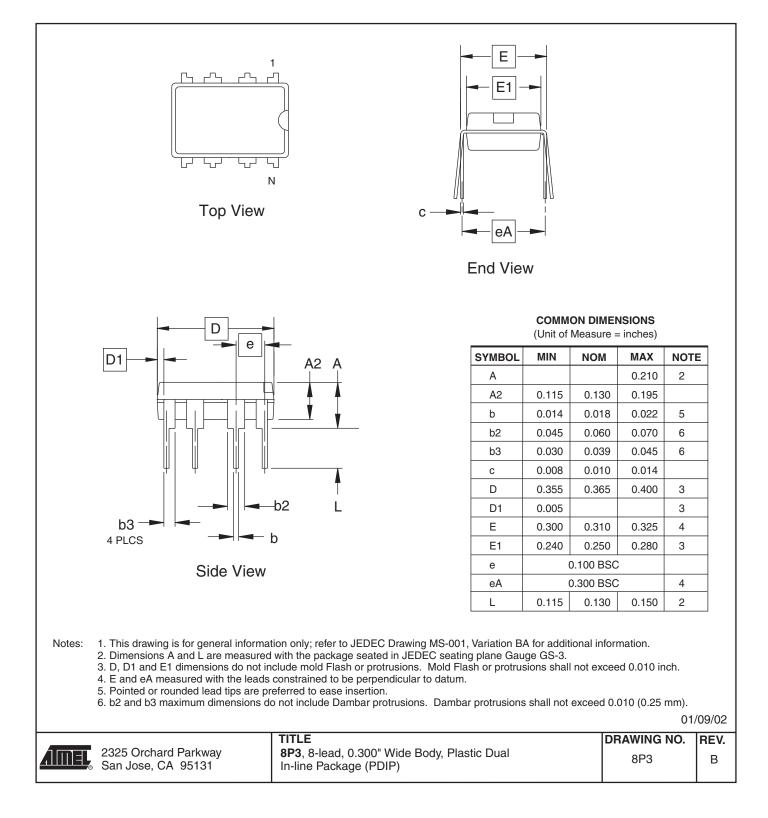
Package Type		
8P3	8-lead, 0.300" Wide, Plastic Dual Inline Package (PDIP)	
8S2	8-lead, 0.209" Wide, Plastic Small Outline Package (EIAJ SOIC)	
S8S1	8-lead, 0.150" Wide, Plastic Gull-Wing Small Outline (JEDEC SOIC)	
20M1	20-pad, 4 x 4 x 0.8 mm Body, Lead Pitch 0.50 mm, Micro Lead Frame Package (MLF)	
10M1	10-pad, 3 x 3 x 1 mm Body, Lead Pitch 0.50 mm, Micro Lead Frame Package (MLF)	



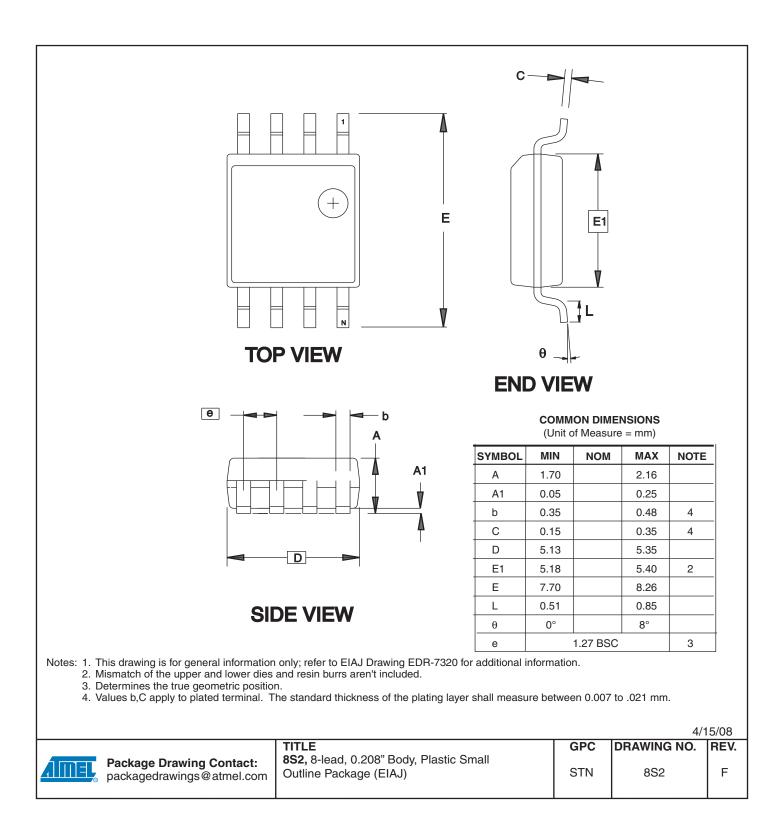


7. Packaging Information

7.1 8P3



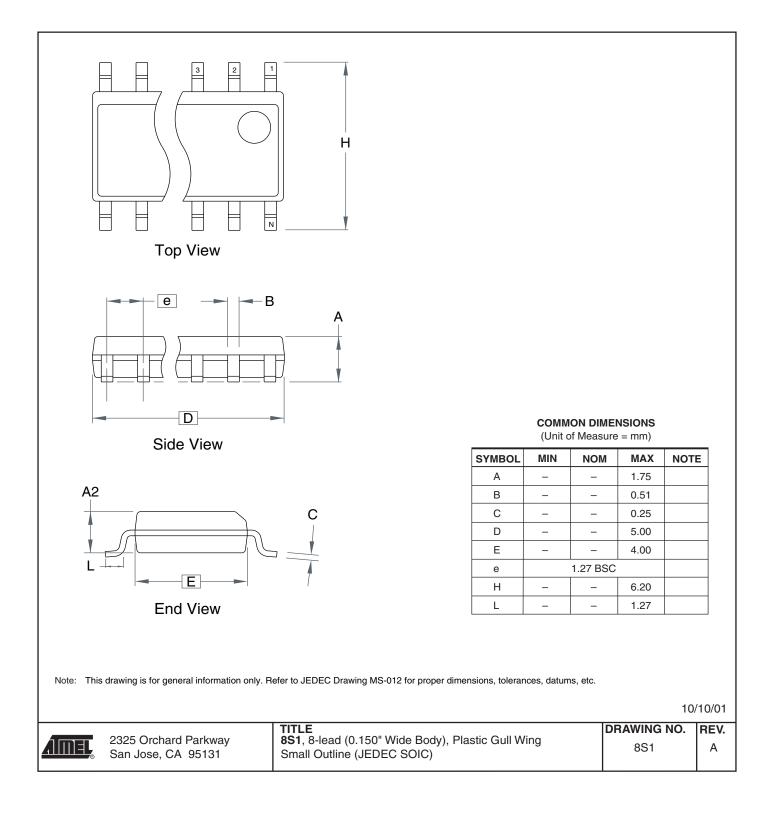
7.2 8S2



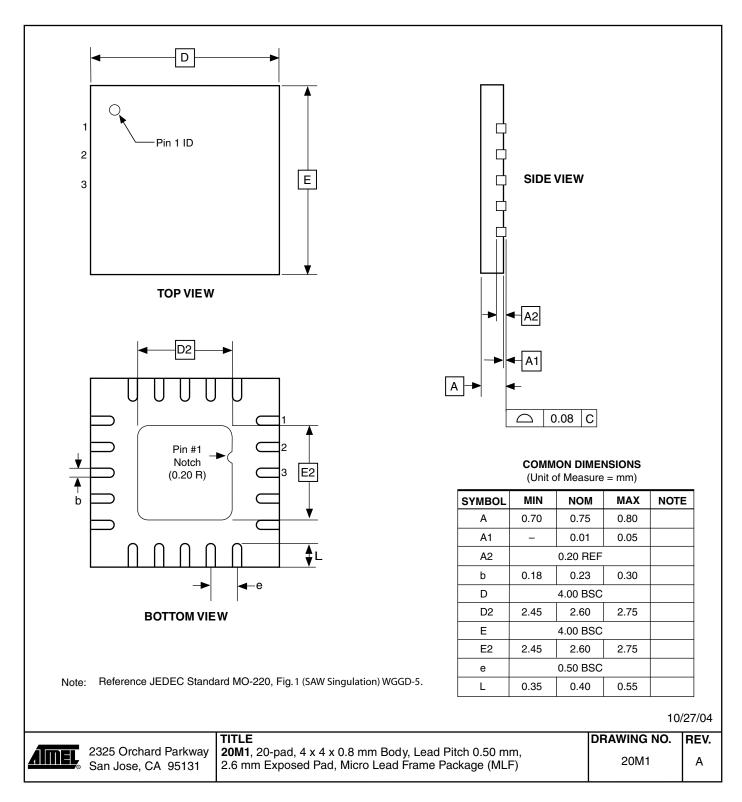




7.3 S8S1

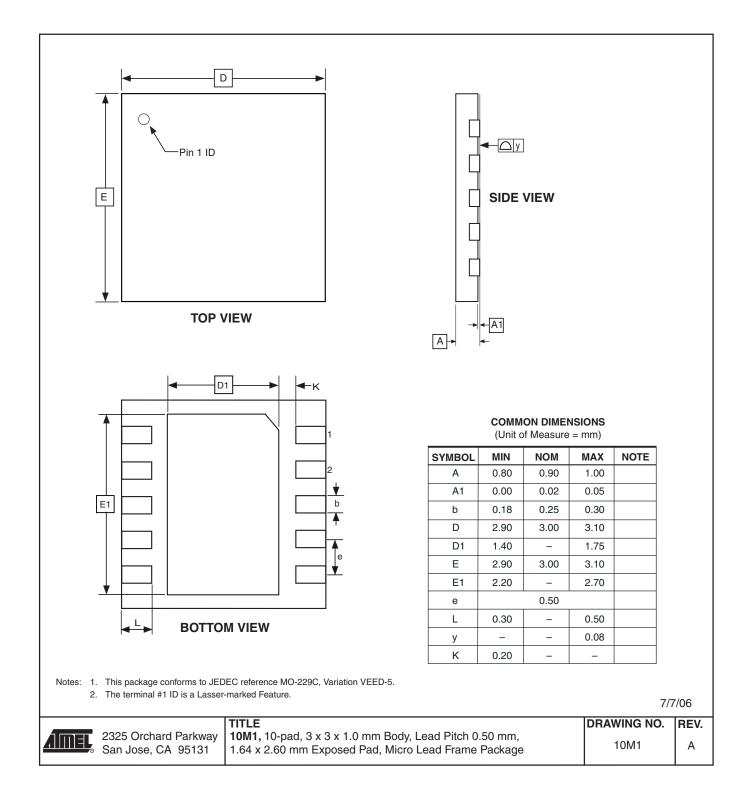


7.4 20M1









8. Errata

The revision letter in this section refers to the revision of the ATtiny13 device.

8.1 ATtiny13 Rev. D

• EEPROM can not be written below 1.9 Volt

1. EEPROM can not be written below 1.9 Volt

Writing the EEPROM at V_{CC} below 1.9 volts might fail.

Problem Fix/Workaround

Do not write the EEPROM when V_{CC} is below 1.9 volts.

8.2 ATtiny13 Rev. C

Revision C has not been sampled.

8.3 ATtiny13 Rev. B

- Wrong values read after Erase Only operation
- High Voltage Serial Programming Flash, EEPROM, Fuse and Lock Bits may fail
- Device may lock for further programming
- debugWIRE communication not blocked by lock-bits
- Watchdog Timer Interrupt disabled
- EEPROM can not be written below 1.9 Volt

8.3.1 Wrong values read after Erase Only operation

At supply voltages below 2.7 V, an EEPROM location that is erased by the Erase Only operation may read as programmed (0x00).

Problem Fix/Workaround

If it is necessary to read an EEPROM location after Erase Only, use an Atomic Write operation with 0xFF as data in order to erase a location. In any case, the Write Only operation can be used as intended. Thus no special considerations are needed as long as the erased location is not read before it is programmed.

8.3.2 High Voltage Serial Programming Flash, EEPROM, Fuse and Lock Bits may fail

Writing to any of these locations and bits may in some occasions fail.

Problem Fix/Workaround

After a writing has been initiated, always observe the RDY/BSY signal. If the writing should fail, rewrite until the RDY/BSY verifies a correct writing. This will be fixed in revision D.

8.3.3 Device may lock for further programming

Special combinations of fuse bits will lock the device for further programming effectively turning it into an OTP device. The following combinations of settings/fuse bits will cause this effect:

- 128 kHz internal oscillator (CKSEL[1..0] = 11), shortest start-up time
- (SUT[1..0] = 00), Debugwire enabled (DWEN = 0) or Reset disabled RSTDISBL = 0.
- 9.6 MHz internal oscillator (CKSEL[1..0] = 10), shortest start-up time
 (SUT(1, 0) = 00), Debugwire enabled (DWEN = 0) or Reset disabled RSTDISE
 - (SUT[1..0] = 00), Debugwire enabled (DWEN = 0) or Reset disabled RSTDISBL = 0.





 - 4.8 MHz internal oscillator (CKSEL[1..0] = 01), shortest start-up time (SUT[1..0] = 00), Debugwire enabled (DWEN = 0) or Reset disabled RSTDISBL = 0.

Problem fix/ Workaround

Avoid the above fuse combinations. Selecting longer start-up time will eliminate the problem.

8.3.4 debugWIRE communication not blocked by lock-bits

When debugWIRE on-chip debug is enabled (DWEN = 0), the contents of program memory and EEPROM data memory can be read even if the lock-bits are set to block further reading of the device.

Problem fix/ Workaround

Do not ship products with on-chip debug of the tiny13 enabled.

8.3.5 Watchdog Timer Interrupt disabled

If the watchdog timer interrupt flag is not cleared before a new timeout occurs, the watchdog will be disabled, and the interrupt flag will automatically be cleared. This is only applicable in interrupt only mode. If the Watchdog is configured to reset the device in the watchdog timeout following an interrupt, the device works correctly.

Problem fix / Workaround

Make sure there is enough time to always service the first timeout event before a new watchdog timeout occurs. This is done by selecting a long enough time-out period.

8.3.6 EEPROM can not be written below 1.9 Volt

Writing the EEPROM at V_{CC} below 1.9 volts might fail.

Problem Fix/Workaround

Do not write the EEPROM when V_{CC} is below 1.9 volts.

8.4 ATtiny13 Rev. A

Revision A has not been sampled.

9. Datasheet Revision History

Please note that the referring page numbers in this section refer to the complete document.

9.1 Rev. 2535J-08/10

Added tape and reel part numbers in "Ordering Information" on page 160. Removed text "Not recommended for new design" from cover page. Updated last page.

9.2 Rev. 2535I-05/08

- 1. Updated document template, layout and paragraph formats.
- 2. Updated "Features" on page 1.
- 3. Created Sections:
 - "Calibrated Internal RC Oscillator Accuracy" on page 118
 - "Analog Comparator Characteristics" on page 119
- 4. Updated Sections:
 - "System Clock and Clock Options" on page 23
 - "Calibrated Internal 4.8/9.6 MHz Oscillator" on page 25
 - "External Interrupts" on page 45
 - "Analog Noise Canceling Techniques" on page 88
 - "Limitations of debugWIRE" on page 96
 - "Reading Fuse and Lock Bits from Firmware" on page 99
 - "Fuse Bytes" on page 103
 - "Calibration Bytes" on page 104
 - "High-Voltage Serial Programming" on page 108
 - "Ordering Information" on page 160
- 5. Updated Figure:
 - "Analog Input Circuitry" on page 87
 - "High-voltage Serial Programming Timing" on page 122
- 6. Moved Figures:
 - "Serial Programming Timing" on page 121
 - "Serial Programming Waveform" on page 121
 - "High-voltage Serial Programming Timing" on page 122
- 7. Updated Tables:
 - "DC Characteristics, $T_A = -40$ °C to +85 °C" on page 115
 - "Serial Programming Characteristics, $T_A = -40$ °C to +85°C, $V_{CC} = 1.8 5.5V$ (Unless Otherwise Noted)" on page 121
- 8. Moved Tables:
 - "Serial Programming Instruction Set" on page 107
 - "Serial Programming Characteristics, $T_A = -40$ °C to +85 °C, $V_{CC} = 1.8 5.5V$ (Unless Otherwise Noted)" on page 121
 - "High-voltage Serial Programming Characteristics $T_A = 25^{\circ}C$, $V_{CC} = 5.0V \pm 10\%$ (Unless otherwise noted)" on page 122
- 9. Updated Register Description for Sections:





- "TCCR0A Timer/Counter Control Register A" on page 69
- "DIDR0 Digital Input Disable Register 0" on page 94
- 10. Updated description in Step 1. on page 106.
- 11. Changed device status to "Not Recommended for New Designs".

9.3 Rev. 2535H-10/07

- 1. Updated "Features" on page 1.
- 2. Updated "Pin Configurations" on page 2.
- 3. Added "Data Retention" on page 6.
- 4. Updated "Assembly Code Example⁽¹⁾" on page 39.
- 5. Updated Table 21 in "Alternate Functions of Port B" on page 54.
- 6. Updated Bit 5 description in "GIMSK General Interrupt Mask Register" on page 46.
- 7. Updated "ADC Voltage Reference" on page 87.
- 8. Updated "Calibration Bytes" on page 104.
- 9. Updated "Read Calibration Byte" on page 108.
- 10. Updated Table 51 in "Serial Programming Characteristics" on page 121.
- 11. Updated Algorithm in "High-Voltage Serial Programming Algorithm" on page 109.
- 12. Updated "Read Calibration Byte" on page 112.
- 13. Updated values in "External Clock Drive" on page 118.
- 14. Updated "Ordering Information" on page 160.
- 15. Updated "Packaging Information" on page 161.

9.4 Rev. 2535G-01/07

- 1. Removed Preliminary.
- 2. Updated Table 7-1 on page 30, Table 8-1 on page 42, Table 18-8 on page 121.
- 3. Removed Note from Table 7-1 on page 30.
- 4. Updated "Bit 6 ACBG: Analog Comparator Bandgap Select" on page 79.
- 5. Updated "Prescaling and Conversion Timing" on page 83.
- 6. Updated Figure 18-4 on page 121.
- 7. Updated "DC Characteristics" on page 115.
- 8. Updated "Ordering Information" on page 160.
- 9. Updated "Packaging Information" on page 161.

9.5 Rev. 2535F-04/06

1. Revision not published.

9.6 Rev. 2535E-10/04

- 1. Bits EEMWE/EEWE changed to EEMPE/EEPE in document.
- 2. Updated "Pinout ATtiny13/ATtiny13V" on page 2.
- 3. Updated "Write Fuse Low Bits" in Table 17-13 on page 110, Table 18-3 on page 118.
- 2. Added "Pin Change Interrupt Timing" on page 45.
- 4. Updated "GIMSK General Interrupt Mask Register" on page 46.
- 5. Updated "PCMSK Pin Change Mask Register" on page 47.
- 6. Updated item 4 in "Serial Programming Algorithm" on page 106.
- 7. Updated "High-Voltage Serial Programming Algorithm" on page 109.
- ²⁰ ATtiny13

- 8. Updated "DC Characteristics" on page 115.
- 9. Updated "Typical Characteristics" on page 122.
- 10. Updated "Ordering Information" on page 160.
- 11. Updated "Packaging Information" on page 161.
- 12. Updated "Errata" on page 166.

9.7 Rev. 2535D-04/04

- 1. Maximum Speed Grades changed: 12MHz to 10MHz, 24MHz to 20MHz
- 2. Updated "Serial Programming Instruction Set" on page 107.
- 3. Updated "Speed Grades" on page 117
- 4. Updated "Ordering Information" on page 160

9.8 Rev. 2535C-02/04

- 1. C-code examples updated to use legal IAR syntax.
- 2. Replaced occurrences of WDIF with WDTIF and WDIE with WDTIE.
- 3. Updated "Stack Pointer" on page 11.
- 4. Updated "Calibrated Internal 4.8/9.6 MHz Oscillator" on page 25.
- 5. Updated "OSCCAL Oscillator Calibration Register" on page 27.
- 6. Updated typo in introduction on "Watchdog Timer" on page 37.
- 7. Updated "ADC Conversion Time" on page 86.
- 8. Updated "Serial Programming" on page 105.
- 9. Updated "Electrical Characteristics" on page 115.
- 10. Updated "Ordering Information" on page 160.
- 11. Removed rev. C from "Errata" on page 166.

9.9 Rev. 2535B-01/04

- 1. Updated Figure 2-1 on page 4.
- 2. Updated Table 7-1, Table 8-1, Table 14-2 and Table 18-3.
- 3. Updated "Calibrated Internal 4.8/9.6 MHz Oscillator" on page 25.
- 4. Updated the whole "Watchdog Timer" on page 37.
- 5. Updated Figure 17-1 on page 105 and Figure 17-2 on page 108.
- 6. Updated registers "MCUCR MCU Control Register", "TCCR0B Timer/Counter Control Register B" and "DIDR0 – Digital Input Disable Register 0".
- 7. Updated Absolute Maximum Ratings and DC Characteristics in "Electrical Characteristics" on page 115.
- 8. Added "Speed Grades" on page 117
- 9. Updated "" on page 120.
- 10. Updated "Typical Characteristics" on page 123.
- 11. Updated "Ordering Information" on page 160.
- 12. Updated "Packaging Information" on page 161.
- 13. Updated "Errata" on page 166.
- 14. Changed instances of EEAR to EEARL.

9.10 Rev. 2535A-06/03

1. Initial Revision.





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